Silicon P Channel MOS Type (U-MOSⅢ)/Silicon Epitaxial Schottky Barrier Diode

SSM5G10TU

DC-DC Converter Applications

- 1.8-V drive
- Combines a P-channel MOSFET and a Schottky barrier diode in one package.
- Low R_{DS(ON)} and Low V_F

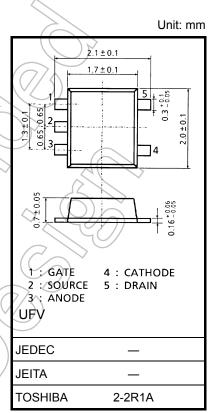
Absolute Maximum Ratings

MOSFET (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-Source voltage		V _{DS}	-20	(Y)	
Gate-Source voltage		V_{GSS}	± 8	(VX)	
Drain current	DC	ID	-1.5	*	
	Pulse	I _{DP} (Note 2)	-3.0		
Drain power dissipation		P _D (Note 1)	0.5	W	
		t = 10 s	0.8		
Channel temperature		T _{ch}	150	°C	

Schottky Barrier Diode (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Repetitive peak reverse voltage	VRRM	20	\ V
Average forward current	(I _{E(AV)})	0.7	A
Peak one cycle surge forward current	IFSM	2 (50 Hz)	A
Junction temperature	/\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	125	√/°C



Weight: 7 mg (typ.)

MOSFET and Diode (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Storage temperature range	T _{stg}	-55 to 125	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

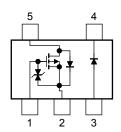
Note 1: Mounted on FR4 board

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ mm}, \text{ Cu pad: } 645 \text{ mm}^2)$

Marking

5 4 KET

Equivalent Circuit (top view)



Start of commercial production 2008-04

MOSFET

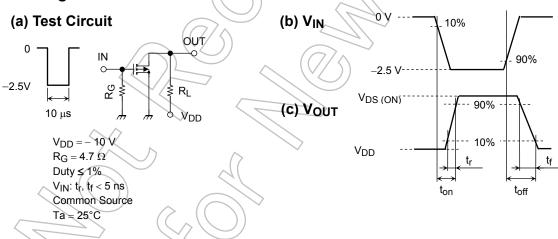
Electrical Characteristics (Ta = 25°C)

Charac	cteristics	Symbol	Test Conditions	Min	Тур.	Max	Unit	
Drain-source breakdown voltage		V (BR) DSS	$I_D = -1 \text{ mA}, V_{GS} = 0 \text{ V}$	-20	_	_	V	
		V (BR) DSX	I _D = -1 mA, V _{GS} = +8 V	-12	_	_	V	
Drain cutoff currer	nt	I _{DSS}	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$	7	1	-10	μА	
Gate leakage curr	ent	I _{GSS}	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0 \text{ V}$	7/	\mathcal{Y}	±1	μΑ	
Gate threshold vo	Itage	V _{th}	$V_{DS} = -3 \text{ V}, I_D = -1 \text{ mA}$	-0.3		-1.0	V	
Forward transfer a	admittance	Y _{fs}	$V_{DS} = -3 \text{ V}, I_D = -1 \text{ A}$ (Note 2)	(1.6)	3.2	_	S	
Drain-source ON-resistance			$I_D = -1.0 \text{ A}, V_{GS} = -4 \text{ V}$ (Note 2)	<u></u>	160	213		
		R _{DS} (ON)	$I_D = -0.8 \text{ A}, V_{GS} = -2.5 \text{ V}$ (Note 2)))_	210	294	mΩ	
			I _D = -0.1 A, V _{GS} = -1.8 V (Note 2)	_	280	430		
Input capacitance		C _{iss}		_	250			
Output capacitance		Coss	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	43	\rightarrow	pF	
Reverse transfer capacitance		C _{rss}		\Diamond _ \	35	<u></u>		
Total Gate Charge	•	Qg			6.4	//-		
Gate-Source Charge		Q _{gs}	V _{DS} = -10 V, I _D = -1.5 A, V _{GS} = -4 V	(/	4.5	_	nC	
Gate-Drain Charge		Q _{gd}			1.9	_		
Switching time	Turn-on time	t _{on}	$V_{DD} = -10 \text{ V}, I_{D} = -1 \text{ A},$	74	12	_		
	Turn-off time	t _{off}	V_{GS} = 0 to -2.5 V, R_{G} = 4.7 Ω		11.2	_	ns	
Drain-source forward	ard voltage	V _{DSF}	I _D = 1.5 A, V _{GS} = 0 V (Note 2)	_	0.88	1.2	V	

Note 2: Pulse test

Precaution

Switching Time Test Circuit



 V_{th} can be expressed as voltage between gate and source when the low operating current value is $I_D = -1$ mA for this product. For normal switching operation, V_{GS} (on) requires a higher voltage than V_{th} and V_{GS} (off) requires a lower voltage than V_{th} .

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(The relationship can be established as follows: $V_{GS\ (off)} < V_{th} < V_{GS\ (on)})$

Be sure to take this into consideration when using the device.

Schottky Barrier Diode

Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Peak forward voltage	V _{FM (1)}	I _F = 0.5 A	_	0.32	0.39	V
Peak forward voltage	V _{FM (2)}	I _F = 0.7 A	7	0.36	0.43	V
Repetitive peak reverse current	I _{RRM}	V _R = 6 V	(-)	25	150	μΑ
Junction capacitance	C _T	V _R = 0 V, f = 1 MHz		143		pF

Precaution

The Schottky barrier diode in this device has large reverse current leakage compared to typical switching diodes. Thus, excessive operating temperature or voltage may cause thermal runaway. To avoid this problem, be sure to take both forward and reverse loss into consideration.

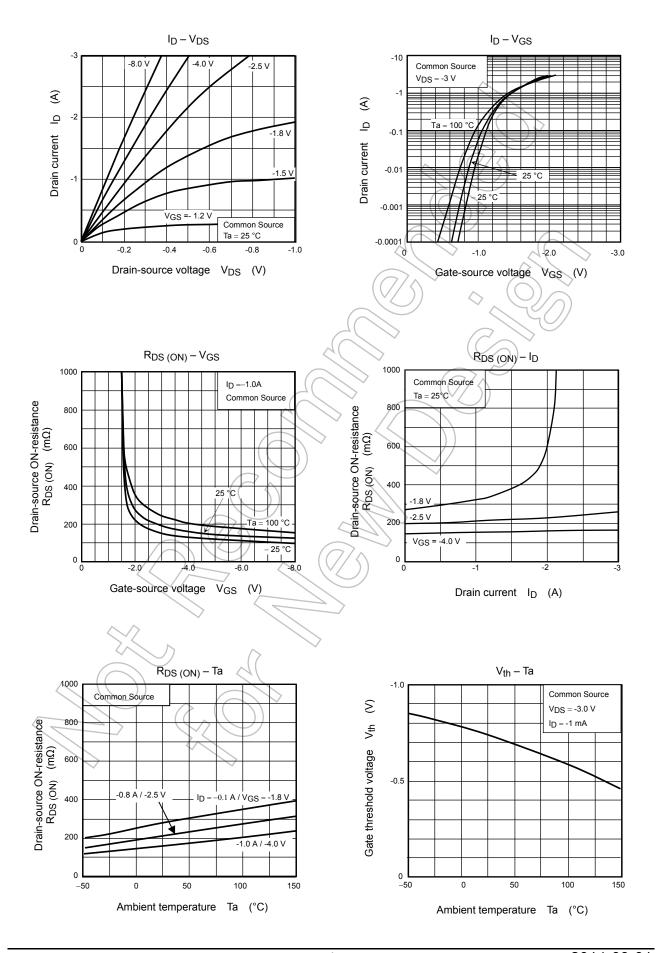
Handling Precaution

When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

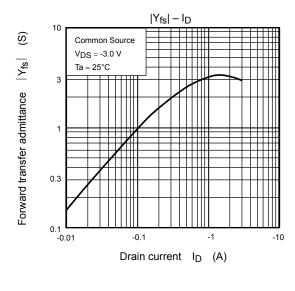
The Channel-to-Ambient thermal resistance $R_{th\ (ch-a)}$ and the drain power dissipation P_D vary according to the board material, board area, board thickness and pad area. When using this device, be sure to take heat dissipation fully into account.

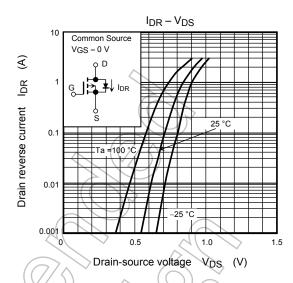


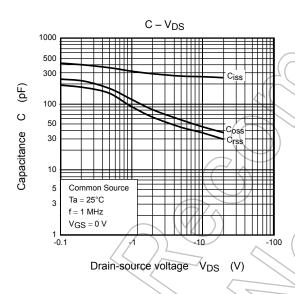
MOSFET

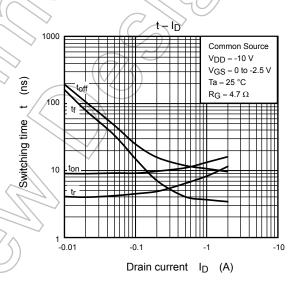


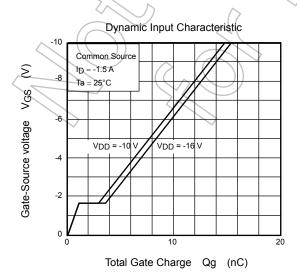
MOSFET





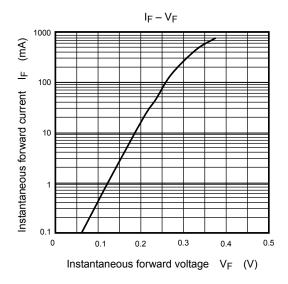


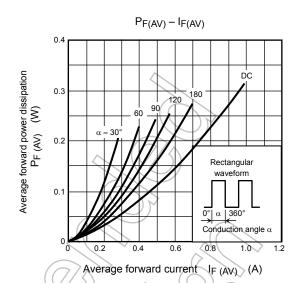


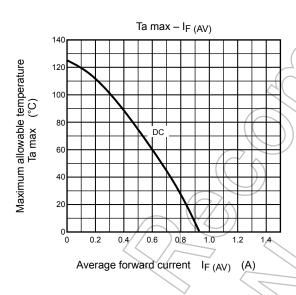


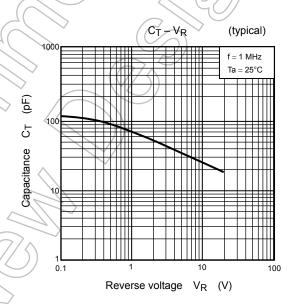
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Schottky Barrier Diode





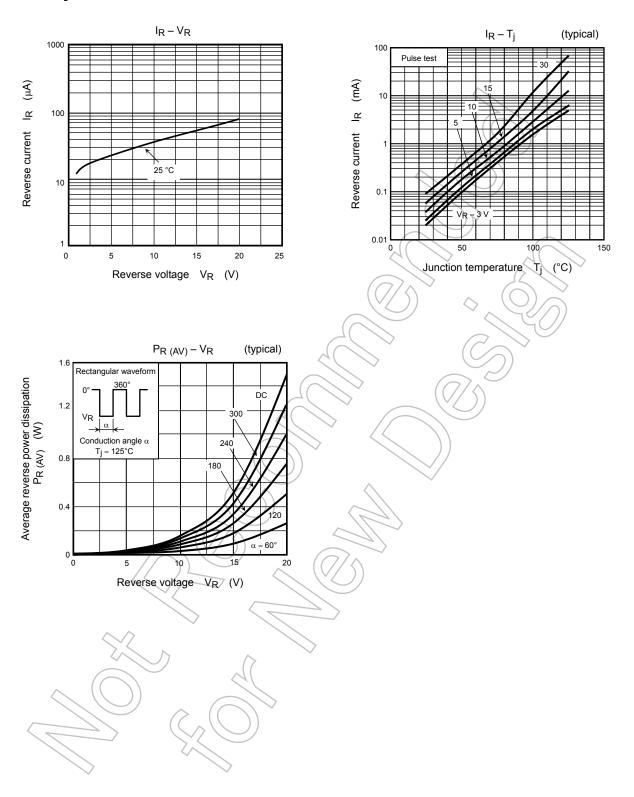




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Schottky Diode



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